

# Product and Process Change Notice

PCN No.	PCN03033	PCN Date	4/19/2021	Effective Date	5/21/2021	
Title	Mold Compound Die Attach Change for 1Mb (x16), 2Mb (x16) and 4Mb (x8 and x16) BGA Package from OSE					

	old compound, BLT1 die attac age from OSE. 30 day effecti	-			
leason For Change					
ncreased product demand.	. Improved manufacturing ef	ficiency and	capacity at assembly sit	e.	
Affected Products		-			
Part Number	Description	Part Num	ber	Descr	iption
MR2A16AMA35	Commercial Temp.	MR2A16A	MA35	Comn	nercial Temp., T&R
MR2A16ACMA35	Industrial Temp.	MR2A16ACMA35R		Industrial Temp., T&R	
MR2A16AVMA35	Extended Temp.	MR2A16AVMA35R		Extended Temp., T&R	
MR2A08AYS35	Commercial Temp.			Commercial Temp., T&R	
MR2A08AMA35	Industrial Temp.	Temp. MR2A08AMA35R		Industrial Temp., T&R	
MR1A16AMA35	Commercial Temp.	. MR1A16AMA35R		Commercial Temp., T&R	
MR1A16ACMA35	Industrial Temp.	MR1A16ACMA35R		Industrial Temp., T&R	
MR1A16AVMA35	Extended Temp.	MR1A16AVMA35R		Extended Temp., T&R	
MR0A16AMA35	Commercial Temp.	MR0A16AMA35R		Commercial Temp., T&R	
MR0A16ACMA35	Industrial Temp.	MR0A16ACMA35R		Indus	trial Temp., T&R
MR0A16AVMA35	Extended Temp.	MR0A16AVMA35R		Exten	ded Temp., T&R
<b>mpact on Form, Fit, Functi</b> No impact <b>Proposed First Ship Date fo</b>	· · · ·				
May 21, 2021					
Key Material Differences					
Material	Old		New		
Mold Compound	Mold Compound Kyocera G1250		Sumitomo G760LB		
BLT1 Die Attach	BLT1 Die Attach Hitachi HR-5104 D				
	Nitto FM-310VI	Nitto EM-310VJ DAF		Sumitomo CRM-1150B Epoxy	
BLT2 Die Attach					

#### Supplier Qual Plan Schedule and Results

Mold Compound and Die attach material change qualification is complete and all Everspin requirements met; a qualification report is available on request.

## Date Qualification Samples Are Available:

Samples are generally available now but please request your specific part number to your Everspin Sales contact.



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### Acceptance of Change

Everspin will consider this change accepted unless specific conditions for acceptance are provided in writing within 30 days of receipt of this notice.

Contact Information		Sample Information Samples	S Available Now			
Product Marketing		Contact Everspin sales:				
Everspin Technologies		<u>http://www.everspin.com/contact-us-everspin-technologies</u>				
(480) 347-1111		If using the on-line sample request please refer to this PCN # to receive samples.				
Originator	Originator					
<u>Date</u>	<u>Title</u>	r Quality Engineer	Name			
4/19/2021	Senio		Paul Drobny Paul DM			
Approval and Release						
<u>Date</u>	<u>Title</u>	or of Fab Ops & Quality	<u>Name</u>			
4/19/2021	Direct		Khaldoun Barakat <i>Alallam Anulat</i>			
<u>Date</u> 4/19/2021	<u>Title</u> VP of	Operations	Norm Armour Man Ma			
<u>Date</u>	<u>Title</u>		Name			
4/19/2021	VP of Sales & Marketing		Troy Winslow			